Enhancing Electron Coherence via Quantum Phonon Confinement in Atomically Thin Nb₃SiTe₆

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The extraordinary properties of two dimensional (2D) materials, such as the extremely high carrier mobility ^{1,2} in graphene and the large direct band gaps in transition metal dichalcogenides MX_2 (M = Mo or W, X = S, Se) monolayers ³, highlight the crucial role quantum confinement can have in producing a wide spectrum of technologically important electronic properties. Currently one of the highest priorities in the field is to search for new 2D crystalline systems with structural and electronic properties that can be exploited for device development. In this letter, we report on the unusual quantum transport properties of the 2D ternary transition metal chalcogenide- Nb₃SiTe₆. We show that the micaceous nature of Nb₃SiTe₆ allows it to be thinned down to one-unit-cell thick 2D crystals using microexfoliation technique. When the thickness of Nb₃SiTe₆ crystal is reduced below a few unit-cells thickness, we observed an unexpected, enhanced weak-antilocalization signature in magnetotransport. This finding provides solid evidence for the long-predicted suppression of electron-phonon interaction caused by the crossover of phonon spectrum from 3D to 2D⁴.

Recent advances in microexfoliation techniques ¹ have made it possible to produce 2D atomic layered crystals that were previously inaccessible to the community. This has significantly expanded the breadth of research on low dimensional physics, as exemplified by the discoveries of exotic quantum phenomena in graphene ⁵ and MX_2 monolayers ^{6,7}. There is currently a significant effort in the field to extend the palate of 2D systems to the more complex ternary materials, with the expectation that the additional elemental complexity will extend the parameter space and possibly give rise to more exotic phenomena. In this paper, we report on the experimental observation of long-predicted suppression of electron-phonon interaction caused by 2D confinement in a new ternary 2D system - Nb₃SiTe₆ few-layer crystals.

Nb₃SiTe₆ was discovered two decades ago but scarcely studied ⁸. As shown in Fig. 1a and 1b, the structure of Nb₃SiTe₆ is similar to that of MX₂ (*e.g.* MoS₂); both are formed from the stacks of sandwich layers, with comparable van der Waals (vdW) gaps. In MX₂, each X-M-X sandwich layer is composed of edge-sharing trigonal MX₆ prisms (Fig. 1c and 1d), whereas the Te-(Nb,Si)-Te sandwich layer of Nb₃SiTe₆ consists of face- and edge-sharing NbTe₆ prisms and Si ions insert into the interstitial sites among these prisms (Fig. 1a and 1b).

We have grown Nb₃SiTe₆ single crystals using chemical vapor transport; the lateral dimension of crystals can reach a few mm (see the inset in Fig. 1e). Sharp (0k0) x-ray diffraction peaks of these crystals

(Fig. 1e) confirm their layered structures and excellent crystallinity. Our resistivity measurements along in-plane ($\rho_{l/}$) and out-of-plane (ρ_{\perp}) directions, as shown in Fig. 1f, indicate that Nb₃SiTe₆ is a quasi-2D metal, with the anisotropic ratio $\rho_{\perp}/\rho_{l/}$ increasing from 9 at 300 K to 22.5 at 2 K (Fig. 1f, left inset).

Our DFT-PBE band structure calculations revealed that the metallicity of Nb₃SiTe₆ originates from the specific bonding state of Nb ions, as detailed in supplementary information. From the projected band structure and density of state shown in Fig. 2a, it can be seen that the valance bands crossing the Fermi level are derived from Nb-4d orbitals, indicating that the transport properties of Nb₃SiTe₆ are dominated by Nb-4*d* electrons. Moreover, the decrease of dimensionality was found to lead to an unambiguous reconstruction of electronic band structure (Fig. 2b and 2c). When the thickness approaches single sandwich layer, the valance bands become much narrower and the gap between conduction and valence bands is doubled (~0.8 eV), while the Fermi level still crosses valence bands.

Atomically thin Nb₃SiTe₆ crystals can be obtained on Si/SiO₂ substrates via microexfoliation that has been widely used for graphene and $MX_2^{1,9}$. The flake thickness was first estimated by the color contrast under an optical microscope and the precise thickness was then measured by an atomic force microscope (AFM). Thin layers of ~3-5 nm are easily produced, and flakes as thin as only one unit cell (bi-layer) are accessible, as illustrated by the micrograph of a large (> 10 µm) bi-layer flake in Figs 3a and 3b.

We further characterized Nb₃SiTe₆ thin flakes through Raman spectra measurements and Transmission Electron Microscope (TEM) observations. As compared to MX_2 which displays only E_{2g}^{1} and A_{1g} phonon modes ¹⁰, Nb₃SiTe₆ exhibits more Raman modes (Fig. 3c) which may be attributed to its relatively complex lattice structure. Unfortunately, we are unable to identify these Raman modes due to the lack of theoretical studies of phonon spectra. However, we observed noticeable red- and blue- shifts caused by the decrease of flake thickness for 165 and 225 cm⁻¹ modes, respectively (see Fig. 3d). Often, such Raman mode shifts reflect the variation of phonon spectra with reducing dimensionality, as seen in MX_2 systems ¹⁰. Our Raman measurements on < 4 nm flakes were unsuccessful since these flakes were easily damaged even by very low laser intensities. The stability of Nb₃SiTe₆ thin flakes were demonstrated by TEM observations. As shown in Fig. 3e, all the [010]-zone electron diffraction spots can be indexed according to the crystal structure of Nb₃SiTe₆, consistent with excellent crystallinity. Moreover, the atomic resolution image shows no visible amorphous structure (Fig. 3f) even after a few weeks exposure to ambient environment, confirming the stability of the few layers Nb₃SiTe₆.

To characterize the electronic properties of Nb₃SiTe₆ thin layers, we fabricated Nb₃SiTe₆ nanodevices using electron-beam lithography. Although we are able to thin Nb₃SiTe₆ crystals down to oneunit-cell, successful devices with good electrical contacts can be prepared only on flakes with the thickness ≥ 6 nm. The inset of Fig. 4b shows an image of a typical device. Overall, we observed a systematic increase of resistivity with the decrease of thickness, as shown in Fig. 4a. For relatively thick flakes (>12 nm), the resistivity presents a temperature dependence similar to that of the bulk sample. When the thickness is decreased below 12 nm, the resistivity displays marked changes in its temperature dependence. These thinner samples are more steeply temperature dependent and develop a low temperature upturn in the resistivity that is more pronounced with decreasing thickness.

In general, there are several mechanisms that can produce a low-temperature resistivity upturn, including Anderson localization, the Kondo effect and weak localization (WL). Through systematic measurements and analyses of the magnetoresistance (MR), we have determined that the observed resistivity upturn at low temperature is primarily attributable to Anderson localization, and not to the other two mechanisms. On one hand, the positive MR in all Nb₃SiTe₆ devices rules out the Kondo effect ¹¹ and WL ¹²⁻¹⁵ (see Figs. 4b and 4c), phenomena associated with negative MR. On the other hand, with decreasing flake thickness, the field dependence of MR evolves from superlinear to sublinear behavior,

with a zero field dip developing gradually (Fig. 4c). This reminisces the signature of weak antilocalization (WAL) in systems with strong spin-orbit coupling (SOC) ¹³⁻¹⁵, or disordered conductors with the electronelectron interaction (EEI) which causes corrections to density of states at the Fermi level ^{15,16}. Fortunately, these two mechanisms can be distinguished by the measurements of angular dependence of magnetoresistance (AMR). The EEI correction to conductance is not sensitive to the magnetic field orientation ^{16,17}, while WAL is ¹⁵ (see the supplementary information). Our AMR data, together with the systematic analyses of MR data for all samples given below, point to a WAL scenario. As seen in Fig. 4d, when the applied field is low (*e.g.* 0.2T), the rotation of the field in the *x-z* plane (see the inset to Fig. 4d) leads to a striking dip in AMR at the direction where the field is parallel to the current. This anisotropic AMR reflects the suppression of WAL by the perpendicular field component *B_z*. Moreover, AMR becomes almost constant when the orientation angle of the field is beyond critical values (*θ_c*), as indicated by the arrows in Fig. 4d. This implies that the Lorentz contributions to the MR are negligible at this field, and WAL is significantly suppressed for *B_z* > *B*cos*θ_c*-0.13T. With increasing field, AMR gradually evolves to a cos²*θ* dependence, as shown by the fits of the data taken at 3T and 9T, indicating the orbital MR ($\propto B_r^2$) dominates.

While the observation of WAL in Nb₃SiTe₆ is not surprising due to relatively strong SOC induced by the heavy elements Nb and Te, the enhancement of WAL signature with reducing samples thickness is unexpected. WAL results from destructive quantum interference of electron waves, and causes enhanced conductivity ¹³⁻¹⁵, and therefore seems incompatible with Anderson localization. As we show below, their coexistence can be understood in terms of an anomalous enhancement of the WAL channel that is superimposed on the Anderson localization background.

To gain more insights into the thickness-dependent evolution of WAL in Nb₃SiTe₆ flakes, we have fitted the magnetotransport data using the Hikami-Larkin-Nagaoka (HLN) model 18 , and extracted

the quantum coherence length l_{ϕ} and spin relaxation length l_{SO} , which characterize the distance scales associated with quantum coherence and SOC, respectively (see supplementary information). With decreasing the sample thickness from 15 nm to 6 nm, the extracted l_{SO} shows very weak thickness dependence. In contrast, l_{ϕ} increases by 50% (Fig. 4e) as thickness is reduced, implying that the observed enhancement of WAL is due to the larger coherence length in the thinner Nb₃SiTe₆ flakes.

We believe that the primary source of enhanced l_{ϕ} in our system is weakened inelastic electronphonon (*e-ph*) scattering ¹³. Other scattering channels such as electron-electron (*e-e*), electron-impurity, and interfacial scattering generally enhance with decreasing sample thickness ^{19,20}. These, of course, also contribute to the overall de-phasing rate, so we would naively expect l_{ϕ} to decrease or at least remain roughly constant as the sample thickness is reduced. Elastic scattering from static impurities, disorder, and interfaces can also result in a decrease of l_{ϕ} through their impact on the electronic diffusion constant. The fact that l_{ϕ} increases significantly as the system is brought through the crossover from 3D to 2D can only be attributed to a dimensional suppression of the inelastic *e-ph* scattering rate.

The detailed characteristics of *e-ph* interaction variation with thickness are further revealed by the temperature dependence of l_{ϕ} , which is obtained from the fitting of magnetotransport data at different temperatures (see supplementary information). As shown in Fig. 4f, l_{ϕ} for 8, 10, and 15 nm samples can be well described by $I_{\phi}^{-2} = I_0^{-2} + AT^{P_e} + BT^{P_{ph} \, 13}$, where l_0 represents a residual zero temperature coherence length, AT^{P_e} and $BT^{P_{ph}}$ are associated with *e-e* and *e-ph* inelastic scatterings respectively. The fittings of $l_{\phi}(T)$ yield $P_e \sim 1$ for all samples (see Tab. 1), consistent with the prediction of the localization theory ¹³; The value of P_{ph} sharply decrease from 3.68 for the 15nm device to 2.21 for the 8 nm one, suggesting the variation of *e-ph* interactions with the flake thickness. More importantly, the

weight of *e-ph* interaction (*i.e.* the prefactor B in Tab. 1) is reduced by two orders of magnitude in the 8 nm sample as compared to the 15 nm flake.

In lower dimensions, the *e-ph* interaction can be modified by the quantum confinement of both the electronic band structure and the phonon spectrum. As shown in Fig. 2, the reduction of thickness leads to significant electronic band flattening in monolayer. Band narrowing is predicted to suppress *e-ph* interaction 21,22 . However, our band structure calculations did not show significant band narrowing in bilayer and thicker Nb₃SiTe₆ flakes (see Fig. 2b). Therefore, the suppression of *e-ph* scattering in our thinner samples cannot be attributed to 2D confinement on electronic band structure. Instead, we believe that confinement plays a much more important role in its modification of the phonon spectrum, which in turn affects the coherence length. As we show in the supplementary information, the phonon wavelength estimated from both the experiments and *ab initio* calculations is ~ 80-100 nm at 2K, much larger than the thickness of those devices showing enhanced WAL, suggesting the phonon spectra crossover from 3D to 2D.

It has already been proposed that the 2D quantum confinement on phonons may lead to the opening of a gap for acoustic phonons 4,23 and therefore suppress *e-ph* interactions 4 . Traditional experimental probes of phonon properties, such as heat capacity and thermal conductivity, are difficult to perform on mesoscopic samples. Furthermore, electron heating measurements on a variety of 2D systems have produced contradictory results 13,24,25 , and the role of dimensionality on *e-ph* scattering remains unclear. On the other hand, quantum interference are extremely sensitive to inelastic scattering 13 . Earlier quantum transport studies on ultra-thin films did not find the evidence for the suppression of *e-ph* scattering with reducing dimensionality $^{26-29}$. However, those studies were made on polycrystalline films that typically have a significant grain-boundary scattering rate, distinct from our crystallized atomically thin Nb₃SiTe₆ layers. In addition, those materials may be much more sensitive to interfacial scattering due to their isotropic lattice structures. In contrast, the highly anisotropic sandwich-like lattice structure of

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Nb₃SiTe₆ leads to weak interlayer electronic coupling (Fig. 1f). Thus the scattering from the crystal/substrate interface, which is likely responsible for our observed resistivity upturn at low temperature, may be quickly "screened" by the adjacent few layers near the substrate so that WAL can occur in layers further away from the interface.

To summarize, we have produced atomically thin analogs of the ternary chalcogenide Nb₃SiTe₆. Using quantum interference as a probe of the electron-phonon scattering rate, we find clear evidence for the long-predicted dimensionality suppression of e-ph interactions that resulted from the crossover from a 3D to 2D phonon spectrum. Such phonon dimensionality effect may also play an important role in the quantum transport properties of other layered crystalline materials.

Methods

The Nb₃SiTe₆ bulk single crystals were synthesized with a stoichiometric mixture of starting elements using the chemical vapor transport. During the growth the temperature was set at 950 °C and 850 °C, respectively, for hot and cold ends of the zoned tube furnace. The composition and structure of these single crystals was confirmed using Energy-dispersive X-ray spectroscopy and X-ray diffraction measurements. To avoid any possible secondary phase in our single crystals, in addition to the careful characterization of bulk single crystals, we double-checked the tiny pieces of single crystals on the scotch tapes used during the exfoliation. For TEM measurements, Nb₃SiTe₆ thin flake was transferred to a Ni/C grid. The Nb₃SiTe₆ nano devices were fabricated using standard electron-beam lithography followed by a deposition of Ti(5nm)/Au (50nm). The transport measurement for both bulk and nano devices are performed in a physical properties measurement system (PPMS).

The electronic band structure calculation was performed using density functional theory in the framework of generalized gradient approximation (GGA) in Perdew-Burke-Ernzerhof ³⁰ parameterization

with periodic boundary conditions using Vienna Ab-initio Simulation Package ³¹. Projector-augmented wave method along with a plane wave basis set with energy cutoff of 220 eV was used. To calculate equilibrium atomic structures, the Brillouin zone was sampled according to the Monkhorst–Pack ³² scheme with a *k*-points mesh $3\times6\times4$. To avoid spurious interactions between neighboring structures in a tetragonal supercell, a minimum of vacuum layer of 20 Å in all non-periodic direction was included. Structural relaxation was performed until the forces acting on each atom were less than 0.05 eV/Å.

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Author contributions

J.H, J.Y.L., H.W.Z., and Z.Q.M. carried out bulk sample growth and characterization including XRD, resistivity and specific heat measurements. J.H, X.L., C.L.Y., and J.W. fabricated nano devices. J.H, X.L., T.J.L., P.W.A., S.R, and L.S. collected resistivity and magnetotransport data for nano devices. J.H and J.B.H. carried out TEM measurements. H.J and D.N. performed Raman spectrum measurements. L.Y.A, Z.I.P, and P.B.S. calculated the electronic structure. J. H, J.W., Z.Q.M., P.W.A, D.N and P.B.S analyzed the data and wrote the manuscript. J.H and X.L. contributes equally to this work.



Figure 1 | Structure and electronic properties of bulk Nb₃SiTe₆. a and c, The crystal structures of (a) Nb₃SiTe₆ and (c) MoS₂. Note that the out-of-plane axis is defined to be the *b*-axis for Nb₃SiTe₆. b and d, The top view of a single layer of (c) Nb₃SiTe₆ and (d) MoS₂. e, Single crystal X-ray diffraction pattern along the (0k0) plane for bulk Nb₃SiTe₆. The out-of-plane lattice constant *b* is determined to be ~1.4 nm, consistent with the previously-reported structure with b = 1.3938(5) nm⁸. Inset in panel e: an optical image of a bulk Nb₃SiTe₆ single crystal. f, Temperature dependences of the in-plane ($\rho_{1/}$) and out of plane (ρ_{\perp}) resistivity for the bulk Nb₃SiTe₆ single crystals. Left inset: the anisotropic ratio ($\rho_{\perp}/\rho_{1/}$) as a function of temperature. Right insets: The contact lead configurations for ρ_{\perp} (upper) and $\rho_{1/}$ (lower) measurements.



Figure 2 | **a-c**, Projected electronic band structure and density of states of Nb₃SiTe₆ for (**a**) bulk, (**b**) bi-layer, and (**c**) mono-layer. The gray and cyan curves in the left panels represent energy bands derived from Nb-4*d* and Te-5*p* orbitals respectively, while the black curves in the right panels represent total density of states. The Fermi energy is marked by the horizontal red lines.



Figure 3 | **AFM**, **TEM and Raman observation of Nb₃SiTe₆ atomically thin layers. a**, Optical image of a Nb₃SiTe₆ thin flake. **b**, AFM image of a selected area from Image **a**; 2L, 5L and 6L represent bi-layers, 5-layers and 6-layers respectively. The inset shows the height of the bi-layer (~1.4nm) from the profile scan. **c**, Raman spectra of Nb₃SiTe₆ crystals with various thickness (displaced vertically). The spectrum for the 4.5 nm flake is multiplied by a factor of 8, in which the hump around 150 nm⁻¹ is caused by laser damage of the Nb₃SiTe₆ crystals. **d**. Enlarged spectra for Raman peaks around 165 and 225 cm⁻¹ for various thickness (displaced vertically). **e**, [010] zone (perpendicular to layers) selected area electron diffraction (SAED) pattern of a Nb₃SiTe₆ thin flake. The overall rectangle arrangement of diffraction spots is consistent with the orthorhombic structure of Nb₃SiTe₆, while the hexagonal pattern of brighter spots reflects the hexagonal Te lattice plane. **f**, High resolution transmission electron microscopy image of the thin flake shown in **c**.



Figure 4 | **Transport properties of Nb₃SiTe₆ nano-devices**. **a**, Temperature dependence of resistivity of Nb₃SiTe₆ thin flakes with various thicknesses. The bulk resistivity data is adopted from Fig. 1f for comparison. The downward arrows mark the resistivity upturns. **b**, Normalized magnetoresistivity, $\Delta \rho / \rho_0 = [\rho(B) - \rho(B=0)]/\rho(B=0)$, of a 8 nm Nb₃SiTe₆ flake. The inset shows the optical image of this device. The magnetic field was applied along the out-of-plane direction. **c**, Normalized magnetoresistivity $\Delta \rho / \rho_0$ at T = 2K for Nb₃SiTe₆ flakes of various thicknesses. Data for different thickness are displaced vertically for clarity. **d**, Isothermal angular magnetoresistance $\Delta \rho / \rho_{min} = [\rho(\theta) - \rho_{min}]/\rho_{min}$ at T = 2K under various magnetic fields for the 10 nm device. ρ_{min} is the resistance minimum which occurs for B//I. The angle θ is the angle between the out-of-plane axis (*z*-axis) and the magnetic field vector. The AMR at 9T is multiplied by a factor of 0.3. The solid line shows the fits of the 9T and 3T data to the $\cos^2 \theta$ dependence. Inset: schematic of the measurement setup. The magnetic field rotates within the x-z plane defined by the current (*x*-axis) and out-of-plane axis (*z*-axis). **e**, The coherence length l_{ϕ} and spin-orbit relaxation length l_{S0} extracted from fitting (see supplementary information for details). The error bars for l_{S0} is too tiny to

be seen. **f**, Temperature dependence of coherence length l_{ϕ} for the 8, 10, and 15 nm samples. The solid lines show the fits for l_{ϕ} (see text).

Table 1 Parameters of e-e and e-ph interactions obtained from the fits of the temperature dependence of l_{ϕ} .

	l_0 (nm)	Α	В	P _e	P_{ph}
8nm	74.54 ±1.12	4.65(±0.10) ×10 ⁻⁵	2.47(±0.37) ×10 ⁻⁸	1.02(±0.05)	3.68(±0.21)
10nm	73.74 ±1.75	6.21(±0.31) ×10 ⁻⁵	3.86(±0.27) ×10 ⁻⁷	1.01(±0.02)	3.11(±0.13)
15nm	72.07 ±1.27	6.03(±0.30) ×10 ⁻⁵	9.23(±0.35) ×10 ⁻⁶	0.95(±0.07)	2.21(±0.11)